# 502371811 06/04/2013

### PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	Partial Assignment

## **CONVEYING PARTY DATA**

Name	Execution Date
SONY MOBILE COMMUNICATIONS AB	06/03/2013

### RECEIVING PARTY DATA

Name:	SONY CORPORATION	
Street Address:	1-7-1 Konan	
Internal Address:	Minato-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	108-0075	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11533046

#### CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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NAME OF SUBMITTER:	Paul A. Harrity
Signature:	/Paul A. Harrity, Reg. No. 39,574/
Date:	06/04/2013

Total Attachments: 1

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OP \$40.00 1

PATENT REEL: 030555 FRAME: 0898

### ASSIGNMENT

This Assignment is between Sony Mobile Communications AB, having an address at Nya Vattentornet, SE-221 88 Lund, Sweden, and Sony Corporation, having an address at 1-7-1 Konan, Minato-ku, Tokyo 108-0075, Tokyo.

By virtue of the corporate relationship respectively between Sony Corporation and Sony Mobile Communications AB and to memorialize the letter of December 18, 2012 from Fumihiko Moriya, VP and Senior General Manager of the Intellectual Property Division of Sony Corporation to Thomas Hedberg, Vice President and Head of Global IPR of Sony Mobile Communications AB, Sony Mobile Communications AB hereby assigns, so far as concerns the United States, the right for Sony Corporation to be identified as first assignee and identify Sony Mobile Communications AB as second assignee for the U.S. patent application 11/533,046 filed in the US Patent and Trademark Office on September 19, 2006.

This Assignment is signed by an authorized representative of Sony Mobile Communications AB.

Sony Mobile Communications AB

Signature:

Title: <u>/2.1/201 Enginee</u>r

PATENT REEL: 030555 FRAME: 0899

RECORDED: 06/04/2013